



#### **Product Summary**

BV <sub>DSS</sub>	RDS(ON) Max	I <sub>D</sub> T <sub>A</sub> = +25°C
-20V	88mΩ @ V <sub>GS</sub> = -8V	-2.9A
-20V	$105m\Omega @ V_{GS} = -4.5V$	-1.8A

#### Description

This new generation MOSFET is designed to minimize the footprint in handheld and Mobile application. It can be used to replace many small signals MOSFET with as really small footprint.

# **Applications**

- Battery managements
- Load switches
- Battery protections
- Handheld and mobile applications

#### 20V P-CHANNEL ENHANCEMENT MODE MOSFET

## **Features and Benefits**

- Low Qg & Qgd
- Small Footprint
- Low Profile 0.30mm Height
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts gualified to AEC-Q100/101/104/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please contact us or your local Diodes representative. https://www.diodes.com/guality/product-definitions/

## **Mechanical Data**

- Package: X2-DSN1006-3
- Terminal Connections: See Diagram Below
- Terminals: Finish Matte Tin Annealed over Copper Pillar (3)

X2-DSN1006-3 ESD Gate Protection Diode S Top View Equivalent Circuit

#### Ordering Information (Note 4)

Part Number	Package	Packing			
Part Nulliper	Гаскауе	Qty.	Carrier		
DMP2088LCP3-7	X2-DSN1006-3	3000	Tape & Reel		

Notes:

1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free

Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.</p>
For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

# Marking Information

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B = Product Type Marking Code YM = Date Code Marking Y or  $\overline{Y}$  = Year (ex: J = 2022) M or  $\overline{M}$  = Month (ex: 3 = March)

#### Date Code Key

Year	2015		2022	2023	2024	2025	2026	2027	2028	2029	2030	2031
Code	С		J	K	L	М	N	0	Р	R	S	Т
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3		5	6	7	Q	Q	0	N	р

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#### Maximum Ratings (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit		
Drain-Source Voltage			V <sub>DSS</sub>	-20	V
Gate-Source Voltage	Vgss	-12	V		
Continuous Drain Current (Note 5) V <sub>GS</sub> = -8V	Steady State	T <sub>A</sub> = +25°C T <sub>A</sub> = +70°C	lD	-2.9 -2.4	А
Continuous Drain Current (Note 5) $V_{GS} = -4.5V$	Steady State	T <sub>A</sub> = +25°C T <sub>A</sub> = +70°C	ID	-1.8 -1.4	А
Pulsed Drain Current (Note 6)	Ідм	-15	А		
Human Body Model (HBM)	V(ESD)	4	kV		

# **Thermal Characteristics**

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 7)	PD	0.57	W
Thermal Resistance, Junction to Ambient $@T_A = +25^{\circ}C$ (Note 7)	Reja	217	°C/W
Power Dissipation (Note 5)	PD	1.13	W
Thermal Resistance, Junction to Ambient $@T_A = +25^{\circ}C$ (Note 5)	Reja	110	°C/W
Operating and Storage Temperature Range	TJ, TSTG	-55 to +150	°C

## Electrical Characteristics (@TA = +25°C, unless otherwise specified.)

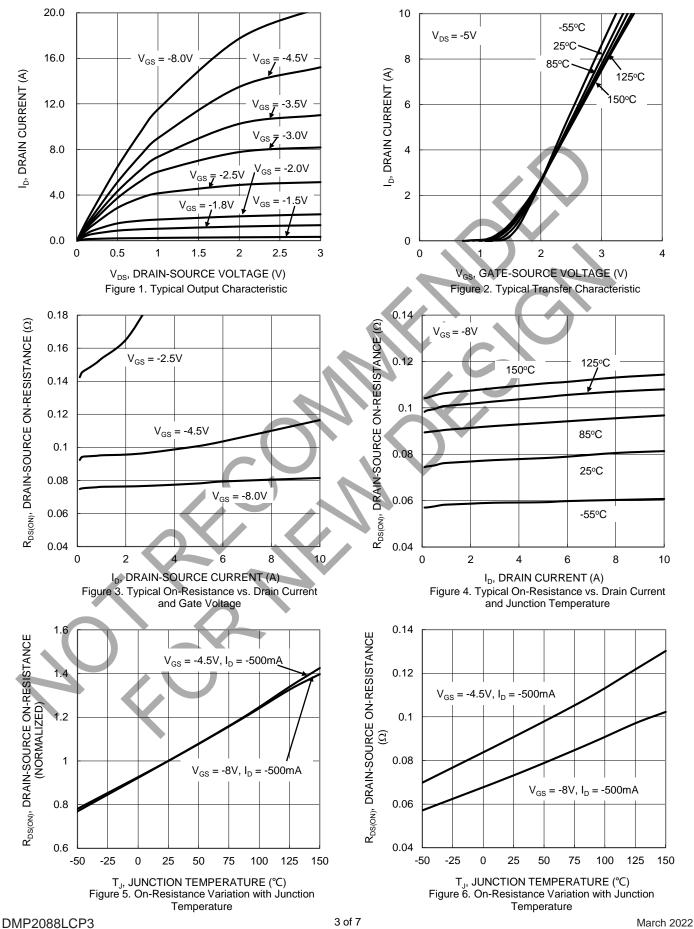
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 8)						
Drain-Source Breakdown Voltage	BVDSS	-20			V	V <sub>GS</sub> = 0V, I <sub>D</sub> = -250µA
Zero Gate Voltage Drain Current T <sub>J</sub> = +25°C	loss	_	—	-100	nA	$V_{DS} = -16V, V_{GS} = 0V$
Gate-Source Leakage	lgss	<b></b>	—	-50	nA	$V_{GS} = -12V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 8)						
Gate Threshold Voltage	VGS(TH)	-0.7	-1.0	-1.2	V	$V_{DS} = V_{GS}$ , $I_D = -250 \mu A$
		-	73	88		$V_{GS} = -8V, I_D = -0.5A$
Static Drain-Source On-Resistance	<b>B</b> PO(0)		90	105	mΩ	$V_{GS} = -4.5V, I_{D} = -0.5A$
Static Drain-Source On-Resistance	RDS(ON)		143	174	11152	V <sub>GS</sub> = -2.5V, I <sub>D</sub> = -0.5A
		-	266	750		V <sub>GS</sub> = -1.8V, I <sub>D</sub> = -0.1A
Forward Transfer Admittance	Y <sub>fs</sub>	—	3.4	—	S	V <sub>DS</sub> = -10V, I <sub>D</sub> = -0.5A
Diode Forward Voltage	Vsd	—	-0.75	-1.0	V	V <sub>GS</sub> = 0V, I <sub>S</sub> = -0.5A
Reverse Recovery Charge	Qrr	—	1.0	_	nC	$V_{DD} = -10V, I_F = -1A,$
Reverse Recovery Time	trr	_	5.7	_	ns	di/dt = 100A/µs
DYNAMIC CHARACTERISTICS (Note 9)						
Input Capacitance	Ciss	_	121	160		
Output Capacitance	Coss	—	66	100	pF	$V_{DS} = -10V, V_{GS} = 0V,$ f = 1.0MHz
Reverse Transfer Capacitance	Crss	—	4.3	8		
Series Gate Resistance	R <sub>G</sub>	9	18	36	Ω	$f = 1MHz$ , $V_{GS} = 0V$ , $V_{DS} = 0V$
Total Gate Charge	Qg	—	1.1	1.5		
Gate-Source Charge	Qgs	—	0.17	—	nC	V <sub>GS</sub> = -4.5V, V <sub>DS</sub> = -10V,
Gate-Drain Charge	Q <sub>gd</sub>	—	0.22	—		I <sub>D</sub> = -0.5A
Gate Charge at V <sub>TH</sub>	Qg(th)	—	0.12	—		
Turn-On Delay Time	tD(ON)	—	6.3	12		
Turn-On Rise Time	tR	—	2.8	_		V <sub>DS</sub> = -10V, V <sub>GS</sub> = -4.5V,
Turn-Off Delay Time	t <sub>D(OFF)</sub>	—	17	34	ns	$R_G = 2\Omega$ , $I_D = -0.5A$
Turn-Off Fall Time	tF	—	6	_	1	

 5. Device mounted on FR-4 material with 1-inch<sup>2</sup> (6.45-cm<sup>2</sup>), 2-oz. (0.071-mm thick) Cu.
 6. Repetitive rating, pulse width limited by junction temperature.
 7. Device mounted on FR-4 PCB with minimum recommended pad layout, single sided.
 8. Short duration pulse test used to minimize self-heating effect.
 9. Cupratured by device 1 a productive testing. Notes:

9. Guaranteed by design. Not subject to production testing.



#### DMP2088LCP3



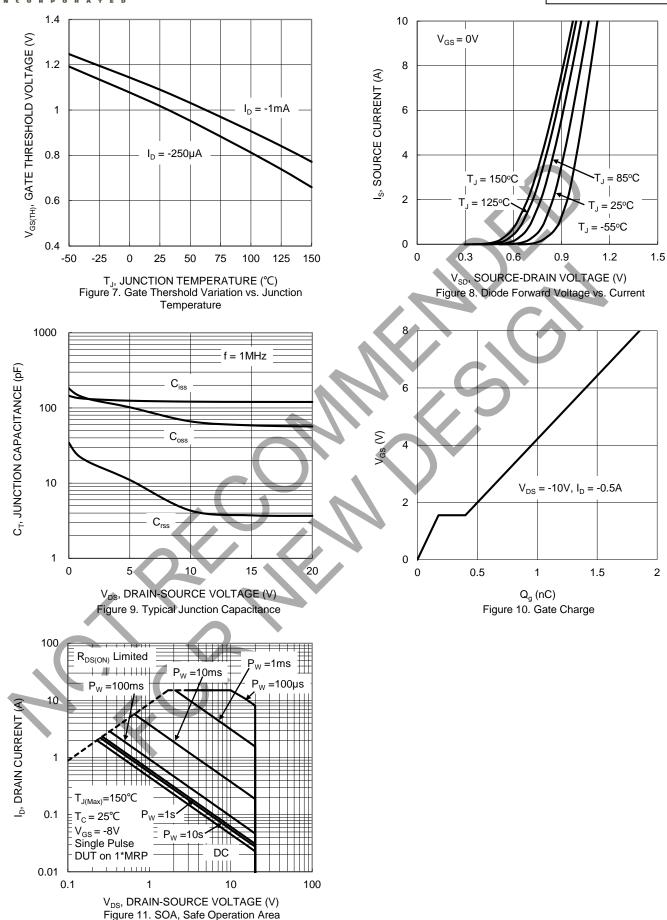
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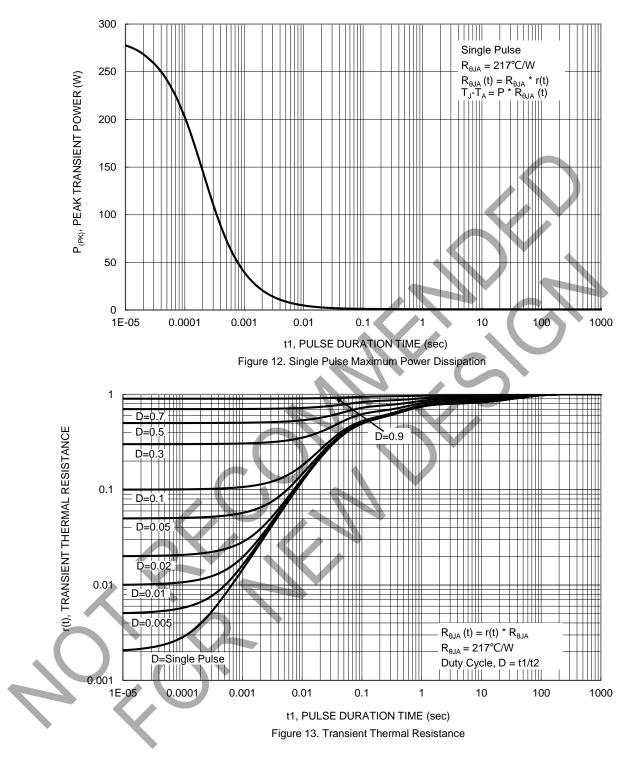
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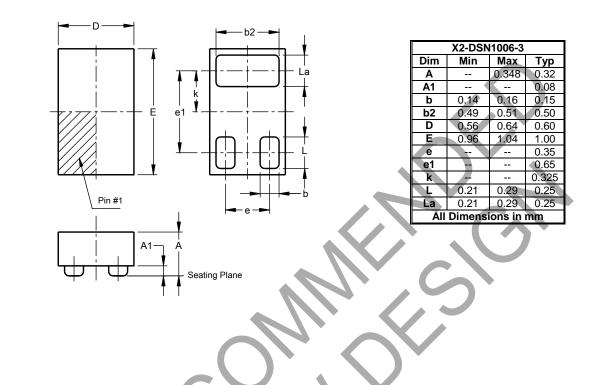




## **Package Outline Dimensions**

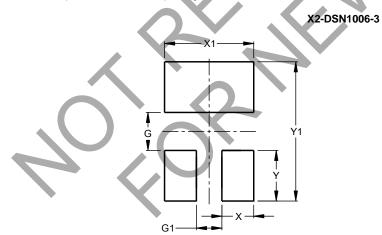
Please see http://www.diodes.com/package-outlines.html for the latest version.

#### X2-DSN1006-3



## **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.



Dimensions	Value (in mm)				
G	0.30				
G1	0.20				
Х	0.25				
X1	0.70				
Y	0.40				
Y1	1.10				



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